

MOS FIELD EFFECT TRANSISTOR

2SJ449

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SJ449 is P-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

Low On-Resistance

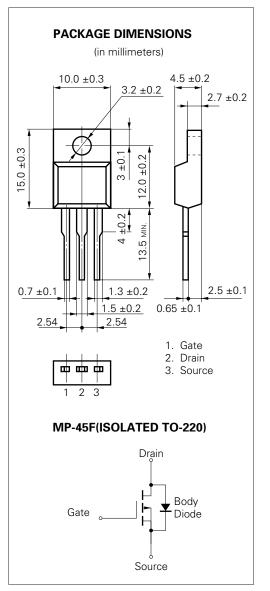
 $R_{DS(on)} = 0.8 \ \Omega \ MAX.$ (@ Vgs = -10 V, ID = -3.0 A)

- Low C_{iss} $C_{iss} = 1040 \text{ pF TYP}.$
- High Avalanche Capability Ratings
- Isolated TO-220 Package

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	-250	V
Gate to Source Voltage	Vgss	∓30	V
Drain Current (DC)	D(DC)	∓6.0	А
Drain Current (pulse)*	D(pulse)	∓24	А
Total Power Dissipation (T _c = 25 $^{\circ}$ C)	Ρ τ1	35	W
Total Power Dissipation (T _A = 25 $^{\circ}$ C)	Р т2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current**	las	-6.0	А
Single Avalanche Energy**	Eas	180	mJ
* $PM < 10 \mu c$ Duty Cycle < 1 %			

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_ch = 25 °C, R_G = 25 $\Omega,$ V_Gs = –20 V \rightarrow 0

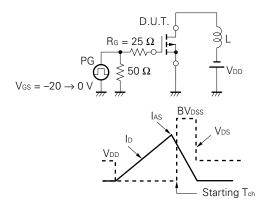


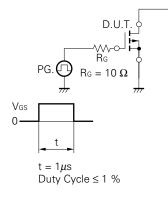
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

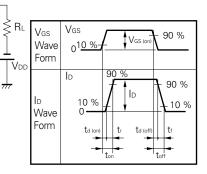
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)		0.55	0.8	Ω	$V_{GS} = -10 \text{ V}, \text{ Id} = -3.0 \text{ A}$
Gate to Source Cutoff Voltage	V _{GS(off)}	-4.0	-4.8	-5.5	V	$V_{DS} = -10 V$, $I_{D} = -1 mA$
Forward Transfer Admittance	y _{fs}	2.0	3.5		S	$V_{DS} = -10 \text{ V}, \text{ Id} = -3.0 \text{ A}$
Drain Leakage Current	IDSS			-100	μΑ	$V_{DS} = -250 \text{ V}, \text{ V}_{GS} = 0$
Gate to Source Leakage Current	lgss			∓100	nA	$V_{GS} = \mp 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1040		pF	$V_{DS} = -10 V$
Output Capacitance	Coss		360		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		70		pF	f = 1 MHz
Turn-On Delay Time	td(on)		24		ns	I _D = -3.0 A
Rise Time	tr		16		ns	$V_{GS(on)} = -10 V$
Turn-Off Delay Time	td(off)		47		ns	$V_{DD} = -125 V$
Fall Time	tr		14		ns	$R_G = 10 \ \Omega, R_L = 42 \ \Omega$
Total Gate Charge	QG		23.1		nC	ID = -6.0 A
Gate to Source Charge	Q _{GS}		7.1		nC	$V_{DD} = -200 V$
Gate to Drain Charge	Qgd		12.9		nC	Vgs = -10 V
Body Diode Forward Voltage	V _{F(S-D)}		0.92		V	IF = −6.0 A, VGS = 0
Reverse Recovery Time	trr		155		ns	$I_F = -6.0 \text{ A}, \text{ V}_{GS} = 0$
Reverse Recovery Charge	Qrr		930		nC	di/dt = 50 A/µs

Test Circuit 1 Avalanche Capability

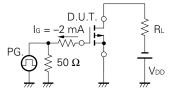
Test Circuit 2 Switching Time



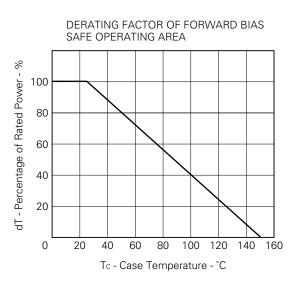




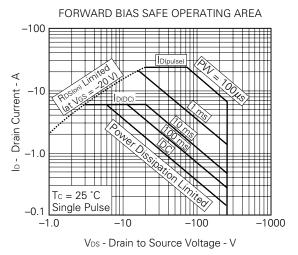
Test Circuit 3 Gate Charge



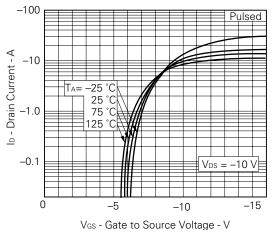
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

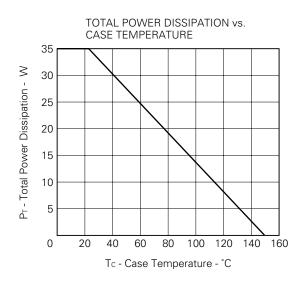


TYPICAL CHARACTERISTICS (TA = 25 °C)

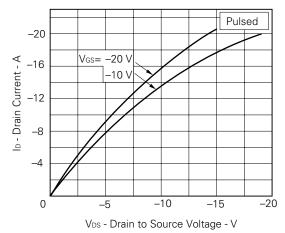


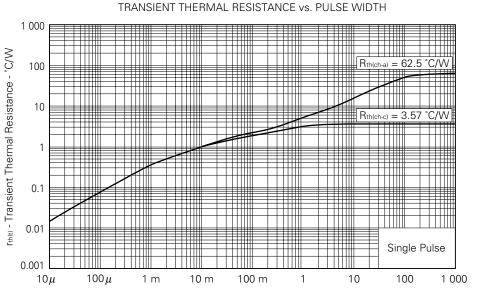


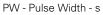


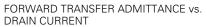


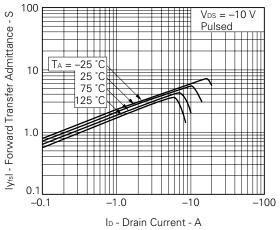
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

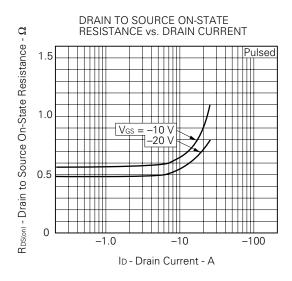




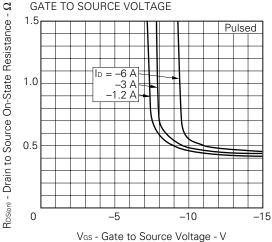




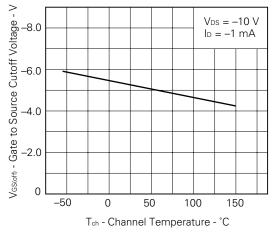


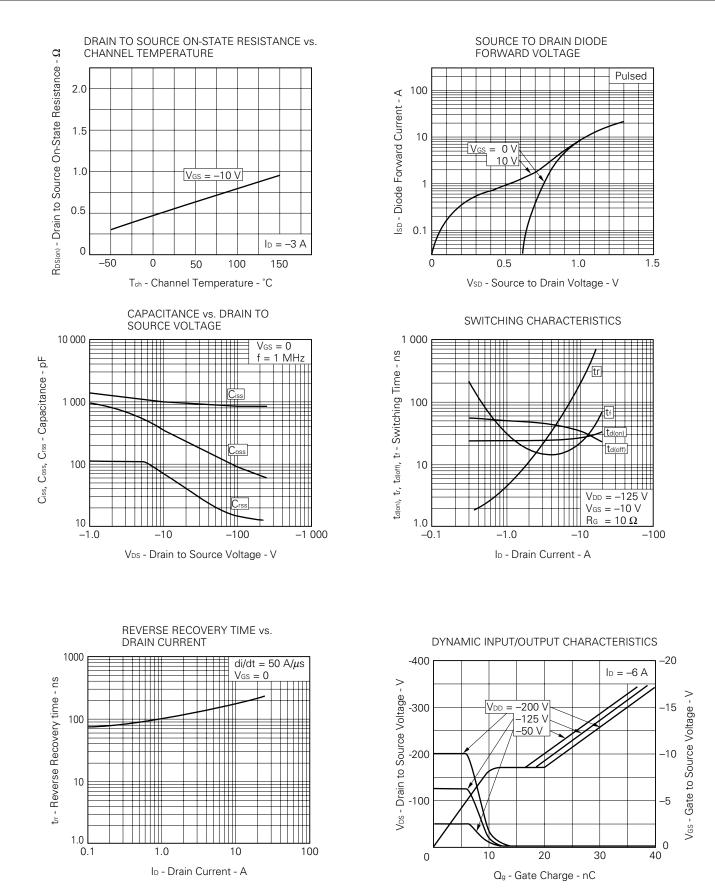


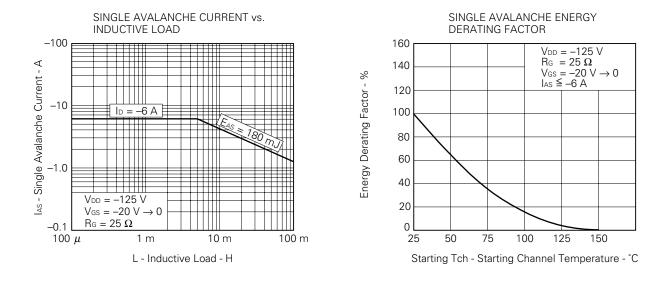
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE







REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.

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